

FIG. 1

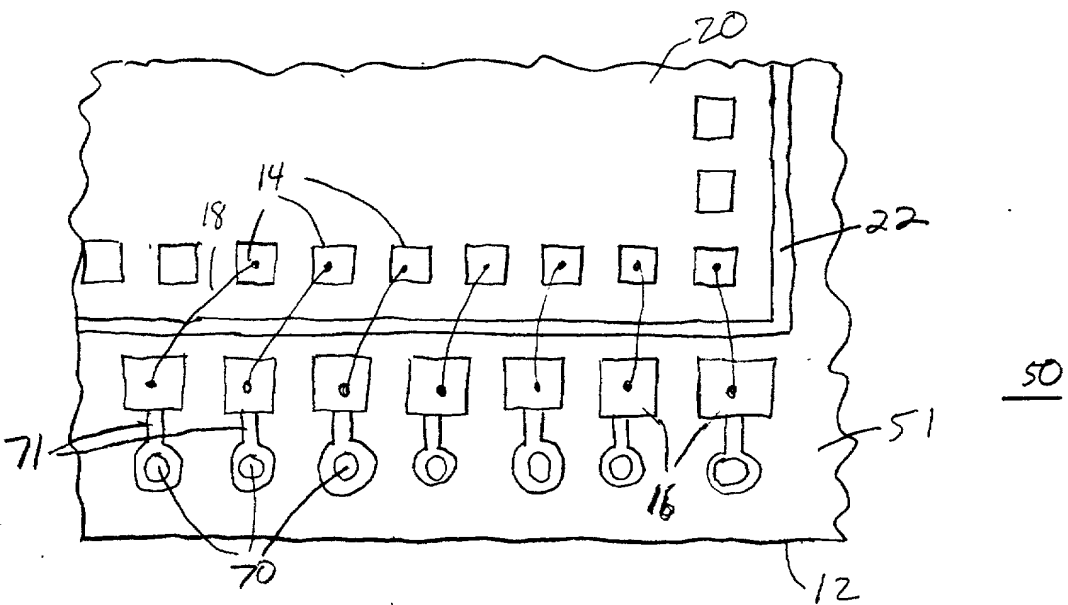


FIG. 2

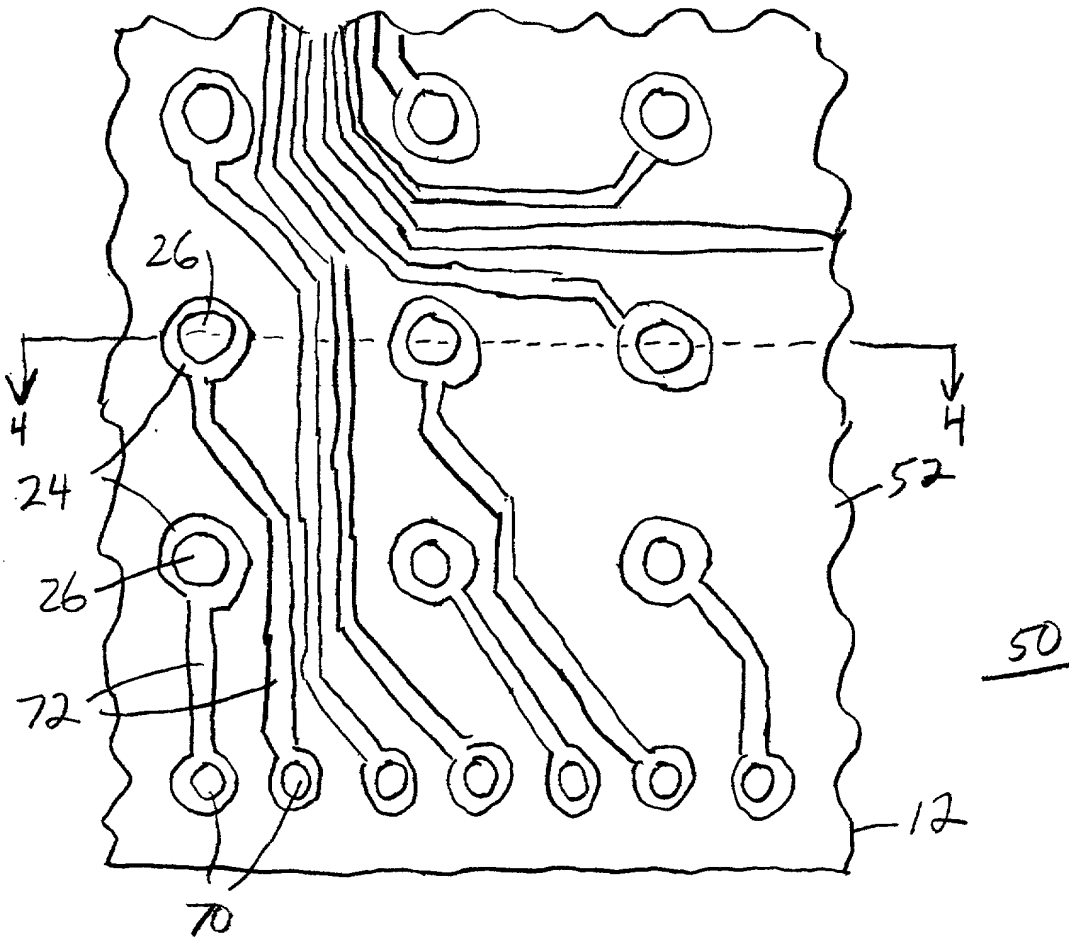


FIG. 3

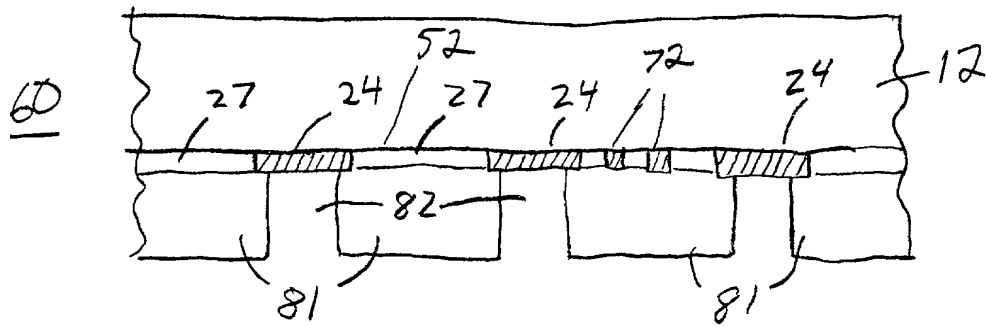


FIG. 4

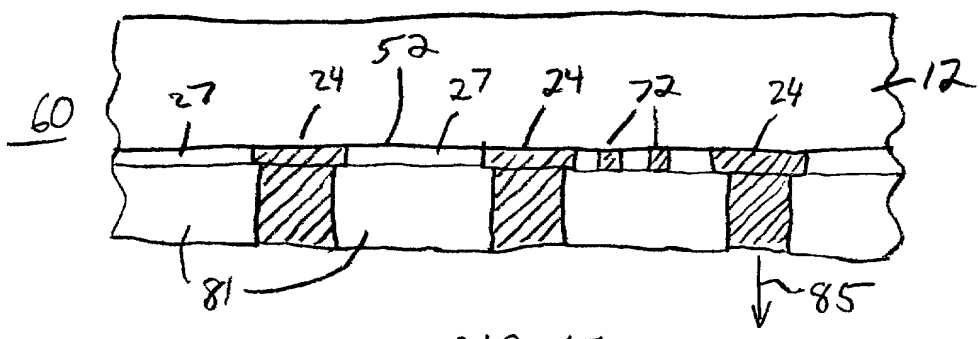


FIG. 5

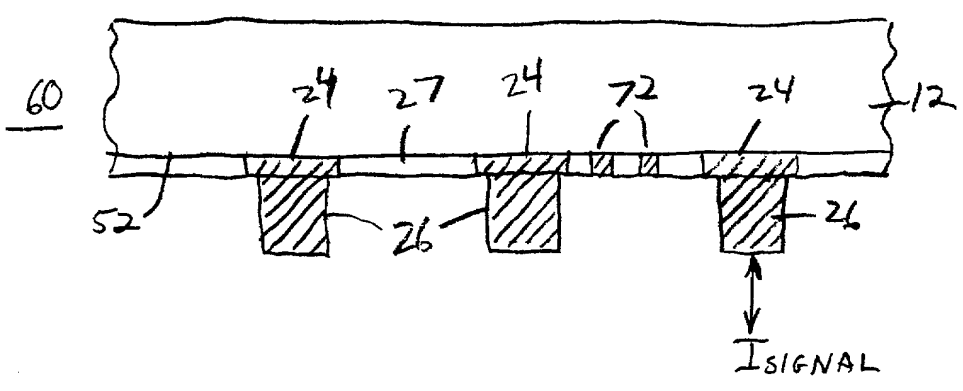


FIG. 6

FIG. 5 is a cross-sectional view of a device structure. The device structure includes a substrate 60 having a series of alternating layers 27, 24, 52, 27, 24, 72, and 24. The total thickness of the substrate 60 is indicated as 12. Below the substrate 60, there are three shaded rectangular regions 81. An arrow 85 points downwards from the right side of the substrate 60.

FIG. 6 is a cross-sectional view of a device structure. The device structure includes a substrate 60 having a series of alternating layers 24, 27, 24, 72, and 24. The total thickness of the substrate 60 is indicated as 12. Below the substrate 60, there are three shaded rectangular regions 26. An arrow 52 points upwards from the left side of the substrate 60. A double-headed vertical arrow labeled "I SIGNAL" is positioned below the rightmost shaded region 26.